

L Number	Hits	Search Text	DB	Time stamp
57	1189	257/692.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/03 18:41
58	727	257/691.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/03 18:42
59	635	257/691.cccls. not 257/692.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/03 18:56
60	14	257/776.cccls. and ((external or power) adj (terminal or lead))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/03 19:11
61	34	257/777.cccls. and ((external or power) adj (terminal or lead))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/03 19:21
62	1	("6208521").PN.	USPAT	2002/04/03 19:39
63	550	361/783.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/03 19:39
64	333	361/783.cccls. and (terminal or lead)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/03 19:40
65	307	(361/783.cccls. and (terminal or lead)) and (device or chip or die)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/03 19:41
-	497	(semiconductor adj device) and (power adj terminal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/03 13:12
-	548	(igbt or (semiconductor adj device)) and (power adj terminal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/03 13:20
-	373	((igbt or (semiconductor adj device)) and (power adj terminal)) and terminals	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/03 13:20

— SEMICONDUCTOR INTEGRATED ADJ CIRCUIT
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